

# Harvatek Surface Mount LED Data Sheet HT-182TW5

Official Product	Product: HT-182TW5	Data Sheet No.		
Tentative Product	*******	HT-182TW5		
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#### **DISCLAIMER**

HARVATEK reserves the right to make changes without further notice to any products herein to improve reliability, function or design. HARVATEK does not assume any liability arising out of the application or use of any product or circuit described herein; neither does it convey any license under its patent rights, nor the rights of others.

#### LIFE SUPPORT POLICY

HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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#### **Product Specifications**

	Specification	Material	Quantity
lv	71.5-360.0mcd		
	@5mA / Ta=25 <sup>o</sup> C, <u>+</u> 10%		
XY	(Refer to page 6&7 for bin range.)		
	@5mA / Ta=25 <sup>o</sup> C, <u>+</u> 0.1%		
Vf	3.2V max		
	@5mA / Ta=25°C , <u>+</u> 0.05 V		
Ir	HT standard		
Resin	Yellow	Epoxy resin	
Carrier tape	Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	

#### Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv,  $\lambda_D$  and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

## ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and

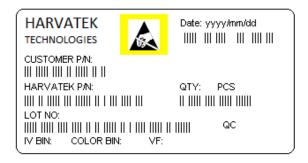
InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

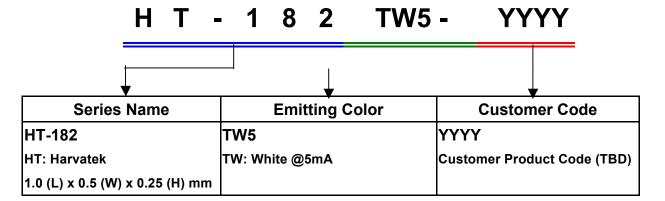
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## **Label Specifications**



### Harvatek P/N:



#### Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	Α	1	Α	2	2	L	1	2
Code 1 2	2	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecuti	ve number		Special code	1
Internal Tracing	g Code	2010-A 2011-B 2012-C 2013-D	1:Jan. 2:Feb.  A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C  26:Z 27:7 28:8 29:9 30:3 31:4	01-	~ZZ		000~ZZZ	

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## ■ Luminous Intensity (Iv) Bin:

Bin	Luminous Intens	sity Range (mcd)	Bin	Luminous Intensity Range (mc	
Biii	Minimum	Maximum	ып	Minimum	Maximum
Q1	71.5	90.0	Q2	90.0	112.5
R1	112.5	142.0	R2	142.0	180.0
S1	180.0	227.0	S2	227.0	285.0
T1	285.0	360.0	T2	360.0	450.0

@20mA / Ta=25° C, Tolerance: <u>+</u> 10%

## **■** Forward Voltage (V<sub>F</sub>) Bin:

Color	Bin Code	Spec. Range
	G2	2.5-2.6V
	G3	2.6-2.7V
	G4	2.7-2.8V
White (TW)	H1	2.8-2.9V
	H2	2.9-3.0V
	Н3	3.0-3.1V
	H4	3.1-3.2V

@20mA / Ta=25 $^{\circ}$ C , Tolerance:  $\underline{+}$  0.05 V

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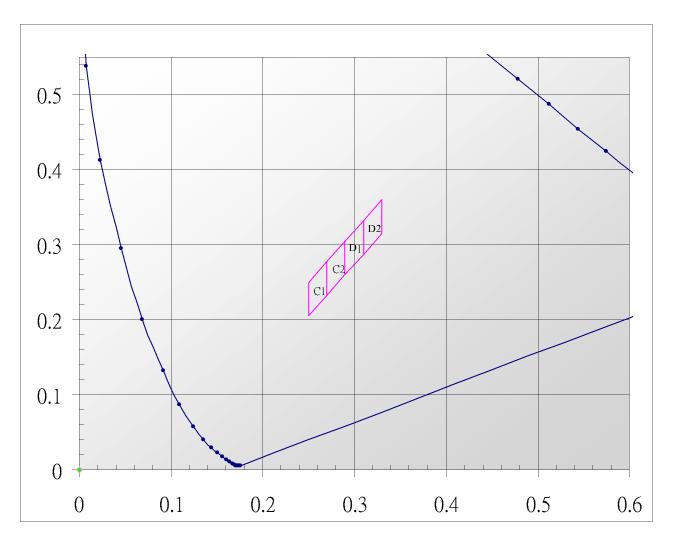
# ■ Chromaticity Bin (for TW only):

	Rank C1				
X	0.2500	0.2700	0.2700	0.2500	
у	0.2500	0.2775	0.2325	0.2050	

	Rank D1				
X	0.2900				
у	0.3050	0.3325	0.2875	0.2600	

	Rank C2					
X	0.2700	0.2900	0.2900	0.2700		
у	0.2775	0.3050	0.2600	0.2325		

	Rank D2					
X	0.3100	0.3300	0.3300	0.3100		
y	0.3325	0.3600	0.3150	0.2875		



@20mA / Ta=25 $^{\circ}$ C, Tolerance:  $\underline{+}$  0.01

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#### **Product Characteristics**

## Absolute Maximum Ratings

Product	Emission Color	P <sub>d</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> * (mA)	V <sub>R</sub> (V)	Top (°C)	T <sub>ST</sub> (°C)
HT-182TW5	White	32	10	80	5	-30°C~+85°C	-40°C~+85°C

<sup>\*</sup> Condition for I<sub>FP</sub> is pulse of 1/10 duty and 0.1msec width

## **Electro-Optical Characteristics**

(Ta 25 °C)

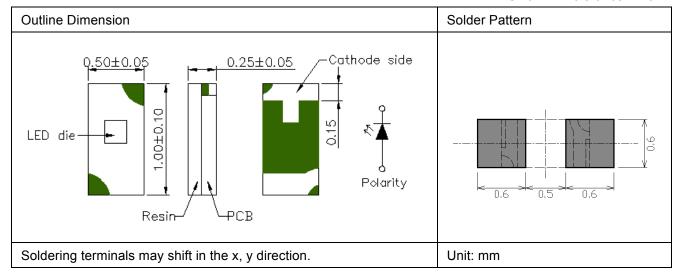
Product	Emission	I <sub>F</sub> (mA)	VF	(V)		λ(nm)		I*∨(n	ncd)
Floduct	Color	IF(IIIA)	typ	max	$\lambda_{D}$	$\lambda_{P}$	Δλ	min	typ
HT-182TW5	White	5	2.8	3.2	X=0.285 Y=0.29	-	-	-	150

<sup>\*</sup> Per NIST standards

## Package Outline Dimension

# Recommended Soldering Pattern for Reflow Soldering

Unit: mm Tolerance: +/-0.1

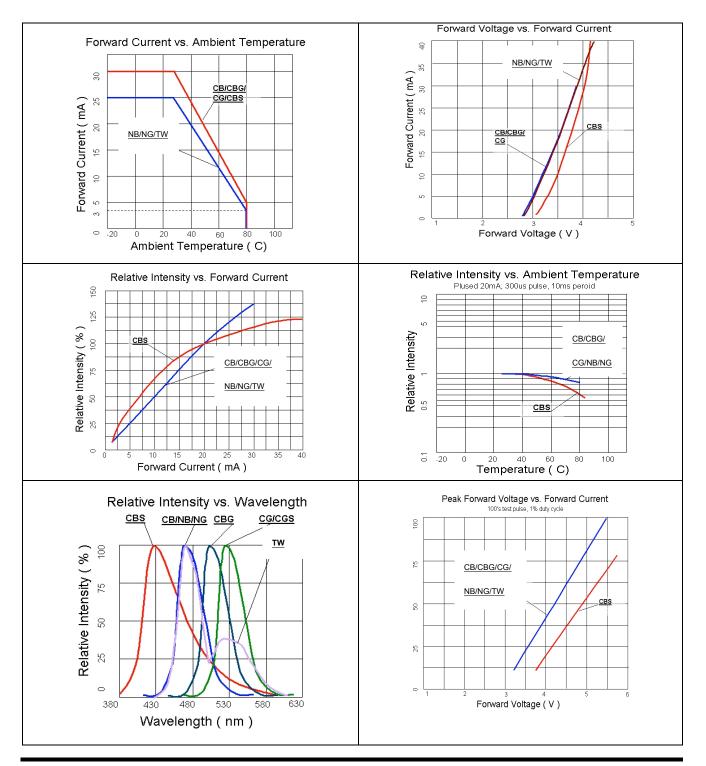


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<sup>\*\*</sup>Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.



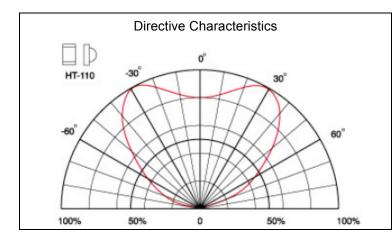
## **Characteristic Curves for TW**

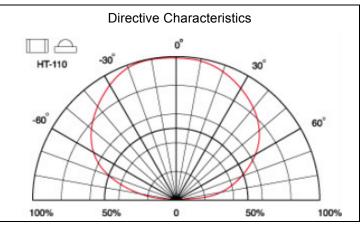


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# Characteristic Curves for All Colors (Radiation Pattern)



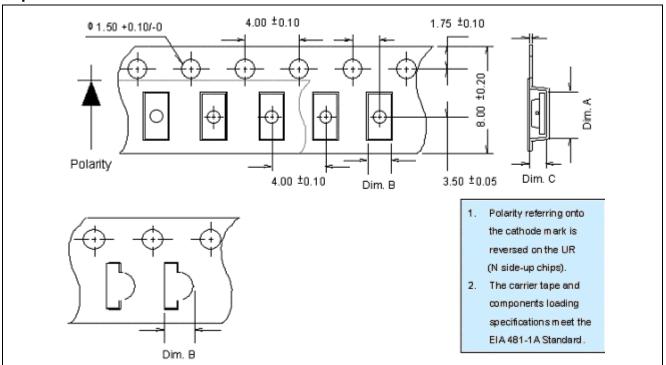


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## **Packaging**

## **Tape Dimension**



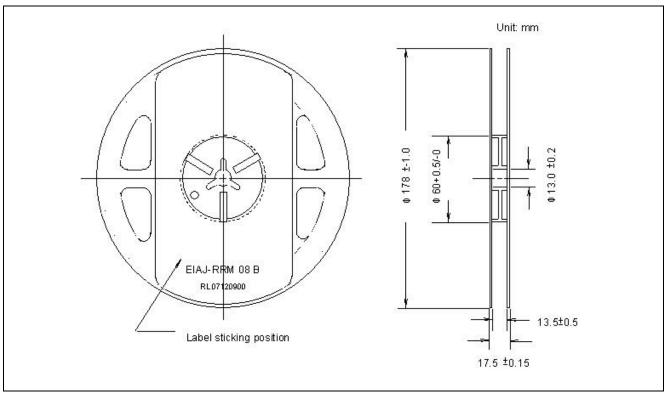
Part No.	Dim. A	Dim. B	Dim. C	Q'ty/Reel
HT-182	1.10±0.05	0.53±0.05	0.35±0.05	4K

Unit: mm

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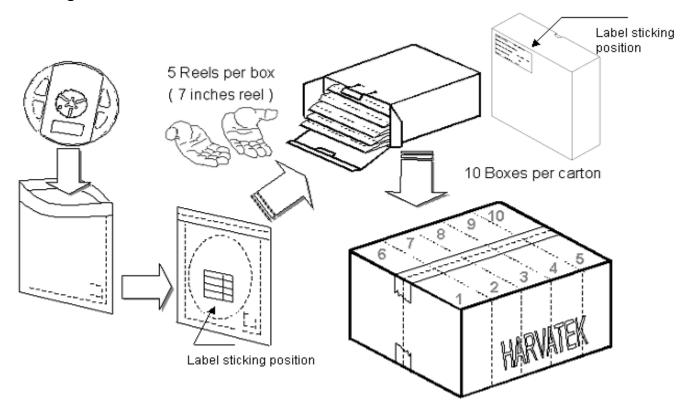
## **Reel Dimension**



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## **Packing**



5 boxes per carton is available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

#### Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv,  $\lambda_D$  and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

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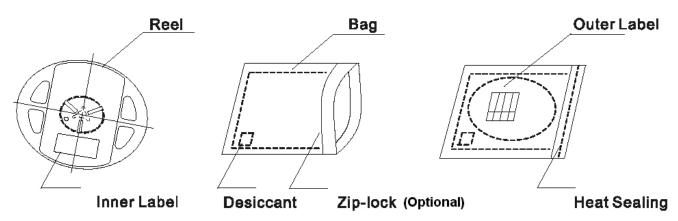


## **Dry Pack**

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



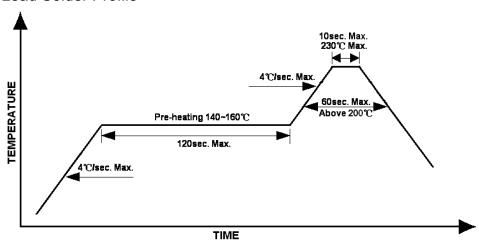
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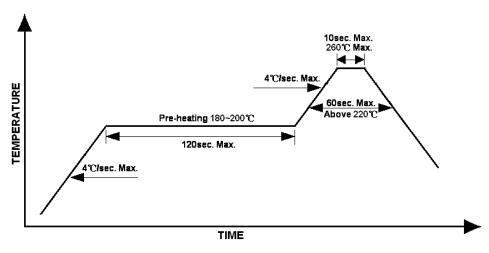
## **Reflow Soldering**

- Recommended tin glue specifications: melting temperature in the range of 178~192 OC
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

### Lead Solder Profile



### Lead-free Solder Profile



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#### **Wave Soldering**

• Maximum soldering temperature is 260°C for 5 seconds.

#### **Precautions**

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

#### Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

## Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter</li>
- Curing: 100 °C max, <3min

#### **Cautions of Pick and Place**

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

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# Reliability

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions	
Precondition	For all reliability monitoring tests according to JEDEC Level 2	J-STD-020	1.) Baking at 85°C for 24hrs 2.) Moisture storage at 85°C/ 60% R.H. for 168hrs	
Solderability	1Q/ 1/ 22/ 0	JESD22-B102-B And CNS-5068	Accelerated aging 155°C/ 24hrs Tinning speed: 2.5+0.5cm/s	
Resistance to soldering heat		CNS-5067	Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s  Dipping soldering terminal only  Soldering bath temperature  A: 260+/-5°C; 10+/-1s  B: 350+/-10°C; 3+/-0.5s	
Operating life test	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs 85°C/ 60%R.H. for 168hrs 2.) Tamb25°C; IF=20mA; duration 1000hrs	
High humidity, high temperature bias	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C Humidity: 85% R.H., IF=5mA Duration: 1000hrs	
High temperature bias	1Q/ 1/ 20	HT specs.	Tamb: 55°C IF=20mA Duration: 1000hrs	
Pulse life test	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty cycle=0.125 (tp=125 $\mu$ s,T=1sec) Duration 500hrs)	
Temperature cycle	1Q/ 1/ 76/ 0	JESD-A104-A IEC 68-2-14, Nb	A cycle: -40 degree C 15min; +85 degree C 15min Thermal steady within 5 min 300 cycles 2 chamber/ Air-to-air type	
High humidity storage test	1Q/ 1/ 40/ 0	CNS-6117	60+3°C 90+5/-10% R.H. for 500hrs	
High temperature storage test	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs	
Low temperature storage test	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs	

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# **Revision History**

Changes since last revision	Page	Version No.	Revision Date
Initial release		1.0	06-19-2013

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